Schottky Barrier Diode

DB2440500L

### **Panasonic**

### DB2440500L

### Silicon epitaxial planar type

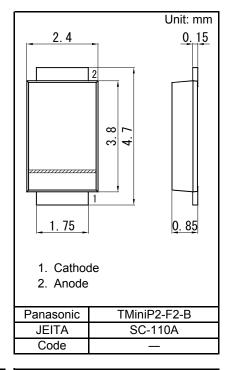
#### For rectification

#### ■ Features

- · Low forward voltage VF
- Forward current (Average) IF(AV) = 3 A rectification is possible
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: 44

#### ■ Packaging

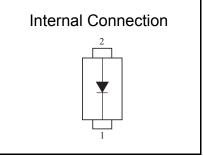
Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)



### ■ Absolute Maximum Ratings Ta = 25 °C

| Parameter                                    | Symbol | Rating      | Unit |
|--|--------|-------------|------|
| Reverse voltage                              | VR     | 40          | V    |
| Maximum peak reverse voltage                 | VRM    | 40          | V    |
| Forward current *1                           | IF     | 3.0         | Α    |
| Non-repetitive peak forward surge current *2 | IFSM   | 30          | Α    |
| Junction temperature *1                      | Tj     | 150         | °C   |
| Operating ambient temperature                | Topr   | -40 to +85  | °C   |
| Storage temperature                          | Tstg   | -55 to +150 | °C   |
| N. 4. T. 00.00                               |        |             |      |

Note: \*1 TI = 80 °C



<sup>\*2 50</sup> Hz sine wave 1 cycle (Non-repetitive peak current)

Doc No. TT4-EA-14187 Revision. 3

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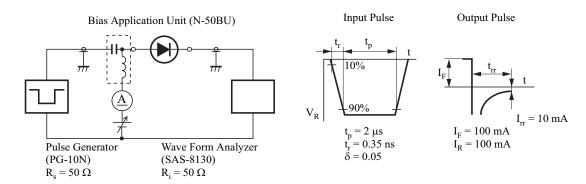
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#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

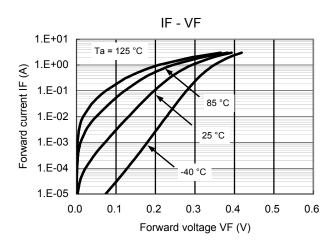
| Parameter                | Symbol | Conditions                    | Min | Тур | Max  | Unit |
|--------------------------|--------|-------------------------------|-----|-----|------|------|
| Forward voltage          | VF     | IF = 3.0 A                    |     |     | 0.44 | V    |
| Reverse current          | IR1    | VR = 20 V                     |     |     | 800  | μA   |
|                          | IR2    | VR = 40 V                     |     |     | 2400 |      |
| Terminal capacitance     | Ct     | VR = 10 V, f = 1 MHz          |     | 57  |      | pF   |
| Reverse recovery time *1 | trr    | IF = IR = 100 mA, Irr = 10 mA |     | 18  |      | ns   |

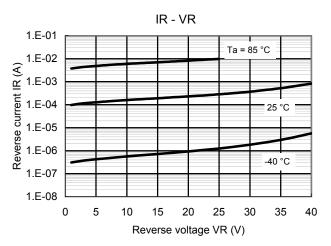
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. \*1 trr test circuit

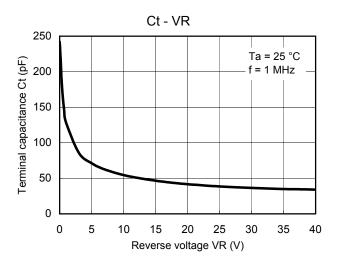


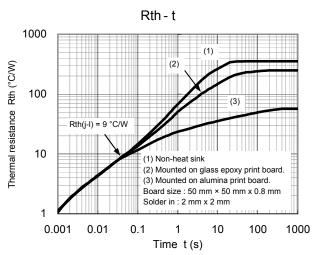
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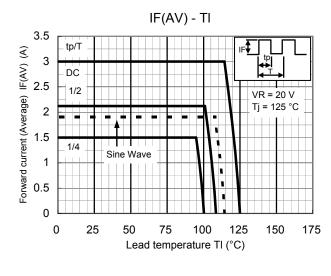
### Technical Data (reference)

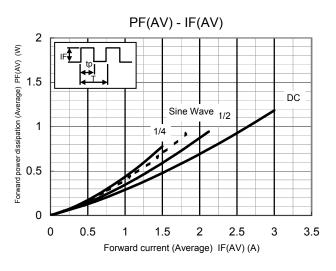












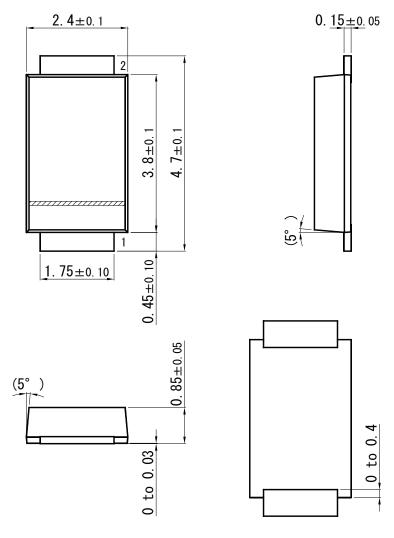
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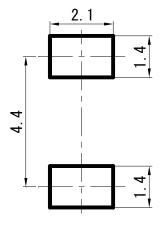
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TMiniP2-F2-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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